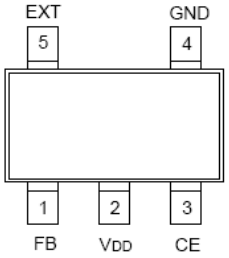
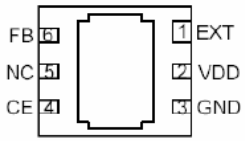
■PIN CONFIGURATION



SOT-25 (TOP VIEW)



USP-6C (BOTTOM VIEW)

* The dissipation pad for the USP-6C package should be solder-plated in recommended mount pattern and metal masking so as to enhance mounting strength and heat release. If the pad needs to be connected to other pins, it should be connected to the VDD pin (Pin #2).

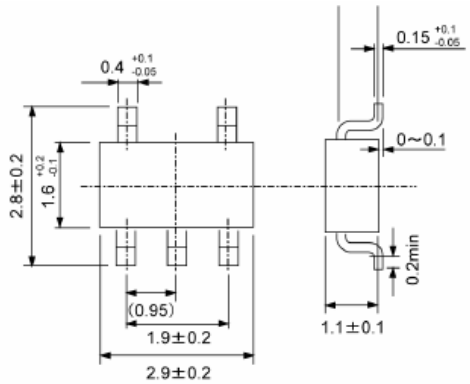
■PIN ASSIGNMENT

PIN NUMBER		PIN NAME	FUNCTION
SOT-25	USP-6C		
1	6	FB	Output Voltage Setting Resistor Connection
2	2	VDD	Supply Voltage
3	4	CE	Chip Enable (Operates when "H" Level)
		CE (/PWM)	PWM/PFM Switch*
4	3	GND	Ground
5	1	EXT	External Transistor Drive Connection
-	5	NC	No Connection

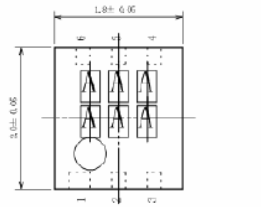
* The XC9122 series combines the CE pin and PWM/PFM switch pin.

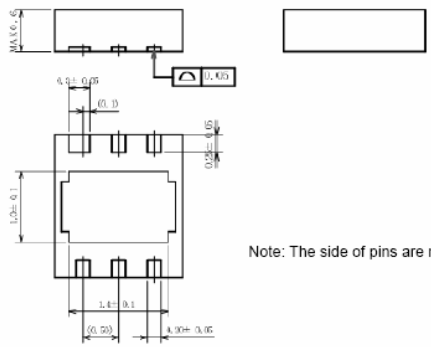
■ PACKAGING INFORMATION

●SOT-25



●USP-6C





Note: The side of pins are not gilded, but nickel is used.